3M

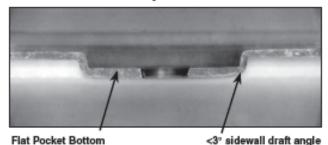
Conductive Polycarbonate Precision Carrier 3000BD

Technical Data - December, 2004

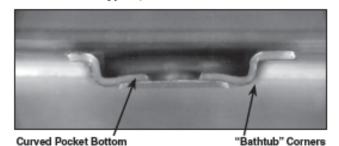
Product Description

3M^{nst} Conductive Polycarbonate Precision Carrier 3000BD for bare die applications is designed to meet the demanding needs of many bare die, flip chip and micro BGA applications traditionally served by trays or other carrier devices. 3M innovation has led to the development of precision pockets, a technical breakthrough allowing 3M to produce highly precise and accurate pockets conforming to and helping protect your chip. Compare 3M Polycarbonate Carrier 3000BD to a typical, traditional heat-formed pocket:

Precision Polycarbonate Pocket



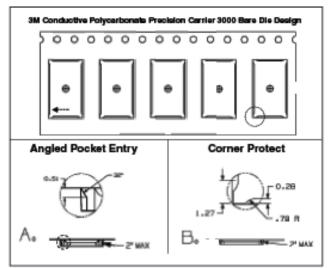
Typical, Traditional Pocket



A large sidewall draft angle in the traditional pocket allows chip movement up the wall and a pocket that is not flat allows Z-axis movement which can cause repeatability problems at the pick-up point.

Product Format

Polycarbonate Carrier 3000BD is available as a splice-free, 8 mm-44 mm carrier in planetary format on 330 m (13") plastic reels for cleanroom applications. For non-cleanroom applications, Polycarbonate Carrier 3000BD is available in planetary or level-wind format on a recyclable 560 mm (22") cardboard reel. Reel capacity will typically be from 30 to 1,000 meters, depending upon pocket depth, pitch and winding format.



Component Protection is Critical

3M precision capabilities allow for innovative ways to help protect your chips from corner damage. Polycarbonate Carrier 3000BD corner protection helps prevent die edge chipping, one of the most common problems when shipping die products.*

^{*} Corner-protect feature not available in 8 mm carrier widths

3M TECHNOLOGIES (S) PTE LTD Supplier:

3M100701 Vendor Part No: Package Description Carrier Tape Package Designator ADP199 Result: PASS Date: April 10, 2012

- Manufacturability Test
 Material on evaluation will not pose any problem with the existing machine.
 - a). Tape feeds freely in machine (no jams).
 - b). No component pick and place issues.
 - c). Spring UPH = 2200
 - d). Units do not slide out pocket or occurrence of tombstone
 - e). Part counting check OK

Result: PASS (Pass/Fail)

2. Peel Force

Parameter Setting (new material) POS Result min: 40.0 Temperature max : 58.9 Seal delay: Pressure: 2.5bar avg.: 62.85

Cover tape Supplier & Part N 3M TECHNOLOGIES (5) PTE LTD / R021-0537X (5.4 mm width)

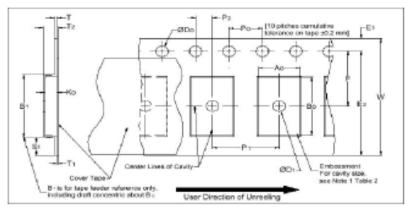
M/C no. used : GPD Peel Backforce tester

Result: PASS (Pass/Fail)

II. Dimensional Check

Parameters	Nominal	Tolerance						Sample Size						Res				
	Stze	Lower	Upper	1	2	3	4	5	6	7	8	9	10	11	12	MIN	MAX	Result
Ao	0.85	0.82	0.88	0.851	0.842	0.846	0.849	0.857	0.845	0.860	0.839	0.850	0.848	0.840	0.856	0.839	0.860	Good
Bo	0.85	0.82	0.88	0.861	0.855	0.857	0.863	0.860	0.855	0.855	0.850	0.855	0.860	0.865	0.859	0.850	0.865	Good
Ko	0.60	0.57	0.63	0.580	0.591	0.578	0.588	0.578	0.592	0.589	0.589	0.577	0.590	0.578	0.588	0.577	0.592	Good

Result: PASS (Pass/Fail)



Representative Carrier Tape Picture (Not actual qualification material)

III. Fit Analysis

Result: PASS (Pass/Fail)

IV. Drop Test

Result: PASS (Pass/Fail)

V. Shake Test

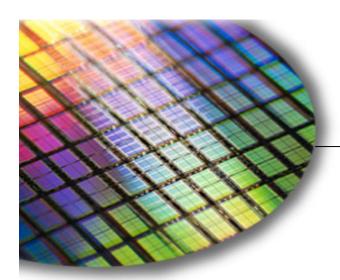
Result: PASS (Pass/Fail)

VI. Supplier Drawing

Design per EIA-481: YES (Yes/No)

Evaluation performed by: Michael Foo

Approved and reviewed by: Winnie Cheong



The World Leader in High-Performance Signal Processing Solutions



100 Units hand test results

First Handtest							
UNIT TESTED Passed		Failed	Parameter failed				
100	96	4	four units are failed at O/S parameter				
Reject verification							
UNIT TESTED	Passed	Failed	Parameter failed				
4	4						

Four units are failed at O/S parameters during first test, but those units passed during verification



PCN 12_0187 Rev. -

	Detailed Dimension Changes					
	Current Carrier (3M105841)	Propose Carrier (3M100701)				
a. K0	0.61+/-0.05 (0.56~0.66)	0.60+/-0.03 (0.57~0.63)				
b. A0	0.88+/-0.05 (0.83~0.93)	0.85+/-0.03 (0.82~0.88)				
c. B0	0.88+/-0.05 (0.83~0.93)	0.85+/-0.03 (0.82~0.88)				